Outgassing Compliant Power Inductors AE541PYA



- High temperature materials allow operation in ambient temperatures up to 155°C
- Passes NASA low outgassing specifications
- Passes vibration testing to 80 G and shock testing to 1000 G
- Tin-lead (Sn-Pb) termination for the best possible board adhesion
- High current and very low DCR
- Soft saturation makes them ideal for VRM/VRD applications.

Core material Composite

Terminations Tin-lead (63/37) over copper.

Weight 1.9 - 2.3 g

Ambient temperature -55°C to +105°C with Irms current Maximum part temperature +155°C (ambient + temp rise). Storage temperature Component: -55°C to +155°C.

Tape and reel packaging: -55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 150 per 7" reel Plastic tape: 16 mm wide, 0.4 mm thick, 12 mm pocket spacing, 7.21 mm pocket depth

	Inductance ²	DCR (mOhms)3		SRF (MHz)4		Isat ⁵	Irms (A) ⁶	
Part number ¹	±20% (μH)	typ	max	min	typ	(A)	20°C rise	40°C rise
AE541PYA161MSZ	0.16	0.75	0.83	166	207	78.0	22.9	27.1
AE541PYA301MSZ	0.30	1.06	1.17	108	135	55.6	19.6	25.1
AE541PYA551MSZ	0.55	1.42	1.56	71	89	43.0	17.6	21.8
AE541PYA651MSZ	0.65	1.75	1.93	59	74	40.0	15.8	19.9
AE541PYA801MSZ	0.80	2.08	2.29	54	67	37.8	15.6	19.4
AE541PYA102MSZ	1.0	2.55	2.81	51	64	34.8	15.0	18.8
AE541PYA122MSZ	1.2	3.10	3.41	34	43	31.2	12.2	16.2
AE541PYA182MSZ	1.8	4.05	4.46	34	43	25.0	11.9	15.8
AE541PYA222MSZ	2.2	5.73	6.33	28	35	19.6	9.9	13.4
AE541PYA332MSZ	3.3	8.56	9.42	26	32	19.4	8.7	11.3
AE541PYA472MSZ	4.7	12.96	14.26	21	26	15.2	7.9	10.2
AE541PYA562MSZ	5.6	13.67	15.03	17	21	13.0	6.4	8.6
AE541PYA682MSZ	6.8	17.84	19.62	16	20	12.8	5.1	6.9

Irms Testing

Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

1. When ordering, please specify screening code:

AE541PYA682MSZ

Screening: Z = Unscreened

Y = Unscreened (SLDC Option A)

W = Unscreened (SLDC Option B)

H = Group A screening per Coilcraft CP-SA-10001

G = Coilcraft CP-SA-10001 Group A (SLDC Option A)

D = Coilcraft CP-SA-10001 Group A (SLDC Option B)

All screening performed to the document's latest revision

Custom screening also available

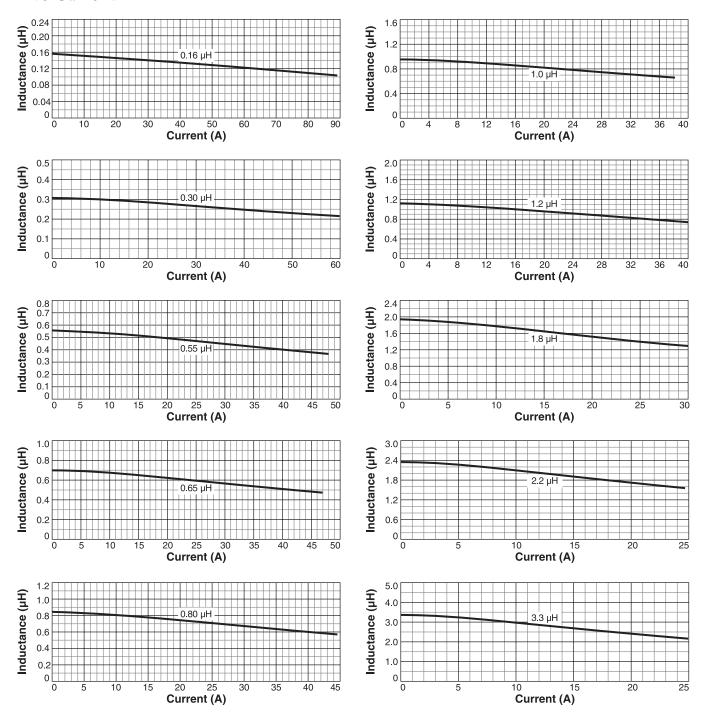
- 2. Inductance tested at 100 kHz, 0.1 Vrms using an Agilent/HP 4192A.
- 3. DCR measured on a micro-ohmmeter.
- 4. SRF measured using an Agilent/HP 4395A or equivalent.
- 5. DC current at 25°C that causes a 30% (typ) inductance drop from its value without current.
- Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.
- 7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.



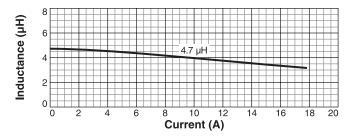
AE541PYA Series (7070)

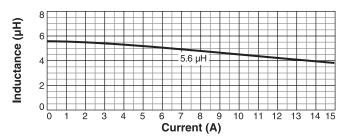
L vs Current

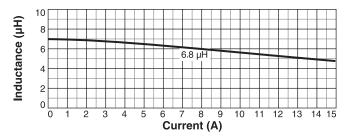


AE541PYA Series (7070)

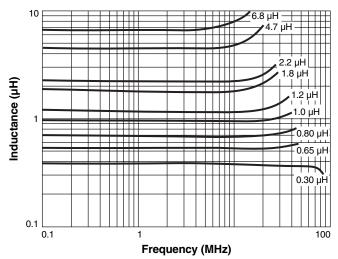
L vs Current

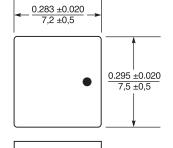


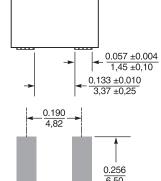


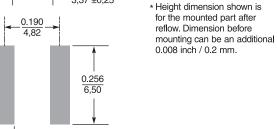


Typical L vs Frequency









0.076 Suggested **Land Pattern**

Dimensions are in $\frac{\text{inches}}{\text{mm}}$

 $\frac{0.276}{7,0}$ max*

0.236 typ

6,0



Please check our web site for latest information.